

N-Channel 60 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|----------------------------------|----|--|--|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | | | | |
| 60 | 0.024 at V _{GS} = 10 V | 50 | | | |
| 60 | 0.028 at V _{GS} = 4.5 V | 40 | | | |

FEATURES

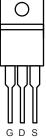
- Halogen-free According to IEC 61249-2-21 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Logic-Level Gate Drive
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC



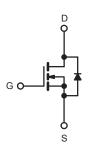
COMPLIANT



TO-220AB



Top View



N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | | |
|--|-------------------------|---|-----------------------------------|------------------|-------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V_{DS} | 60 | V | |
| Gate-Source Voltage | | | V_{GS} | ± 20 | 7 v | |
| Continuous Drain Current ^f | V _{GS} at 10 V | $T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$ | 1 | 50 | | |
| Continuous Drain Current | V _{GS} at 10 V | T _C = 100 °C | ID | 36 | Α | |
| Pulsed Drain Current ^a | | | I _{DM} | 200 | 1 | |
| Linear Derating Factor | | | | 1.0 | W/°C | |
| Linear Derating Factor (PCB Mount)e | | | | 0.025 | VV/ C | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 400 | mJ | |
| Maximum Power Dissipation | T _C = 25 °C | | 0 | 150 | W | |
| Maximum Power Dissipation (PCB Mount)e | T _A = 25 °C | | P_{D} | 3.7 | | |
| Peak Diode Recovery dV/dtc | | | dV/dt | 4.5 | V/ns | |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | - 55 to + 175 | °C | |
| Soldering Recommendations (Peak Temperature)d | for | 10 s | - | 300 ^d | 1 | |

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = 25$ V, starting $T_J = 25$ °C, L = 179 μ H, $R_g = 25$ Ω , $I_{AS} = 51$ A (see fig. 12). c. $I_{SD} \le 51$ A, $I_{AS} = 51$

- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).
- f. Current limited by the package, (die current = 51 A).



| THERMAL RESISTANCE RATINGS | | | | | |
|--|-------------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum Junction-to-Ambient | R _{thJA} | - | 62 | | |
| Maximum Junction-to-Ambient (PCB Mount) ^a | R _{thJA} | - | 40 | °C/W | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 1.0 | | |

Note
a. When mounted on 1" square PCB (FR-4 or G-10 material).

| PARAMETER | SYMBOL | TES | MIN. | TYP. | MAX. | UNIT | |
|---|-----------------------|--|---|------|-------|------------------|------|
| Static | | • | | | ļI | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0, I _D = 250 μA | | 60 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | e to 25 °C, I _D = 1 mA | - | 0.070 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ | | 1.0 | - | 2.5 | |
| Gate-Source Leakage | I _{GSS} | V _{GS} = ± 10 V | | - | - | ± 100 | nA |
| Zaus Cata Valtana Dusin Commant | I _{DSS} | V _{DS} = 60 V, V _{GS} = 0 V | | - | - | 25 | μА |
| Zero Gate Voltage Drain Current | | V _{DS} = 48 V, V _{GS} = 0 V, T _J = 150 °C | | - | - | 250 | |
| Duain Cauras On State Besistance | П | V _{GS} = 10 V | I _D = 21 A ^b | - | 0.024 | ī | Ω |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 4.5 V | I _D = 15 A ^b | - | 0.028 | - | |
| Forward Transconductance | 9 _{fs} | V _{DS} : | = 25 V, I _D = 21A ^b | 23 | - | - | S |
| Dynamic | | • | | | | | |
| Input Capacitance | C _{iss} | $V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz}, \text{ see fig. 5}$ | | - | 190 | | |
| Output Capacitance | C _{oss} | | | - | 920 | - | pF |
| Reverse Transfer Capacitance | C _{rss} | | | - | 170 | - | |
| Total Gate Charge | Qg | | | - | - | 66 | nC |
| Gate-Source Charge | Q_{gs} | $V_{GS} = 5.0 \text{ V}$ | $I_D = 51 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13^b | - | - | 12 | |
| Gate-Drain Charge | Q_{gd} | | | - | - | 43 | 1 |
| Turn-On Delay Time | t _{d(on)} | V_{DD} = 30 V, I_{D} = 51 A, R_{g} = 4.6 Ω, R_{D} = 0.56 Ω, see fig. 10 ^b | | - | 17 | - | - ns |
| Rise Time | t _r | | | - | 230 | - | |
| Turn-Off Delay Time | t _{d(off)} | | | - | 2 | - | |
| Fall Time | t _f | | | - | 110 | - | |
| Internal Drain Inductance | L_D | Between lead, 6 mm (0.25") from package and center of die contact | | - | 4.5 | - | ъU |
| Internal Source Inductance | L _S | | | - | 7.5 | 1 | - nH |
| Drain-Source Body Diode Characteristic | s | | | | | | |
| Continuous Source-Drain Diode Current | I _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 50° | А |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 200 | |
| Body Diode Voltage | V_{SD} | T _J = 25 °C, I _S = 51 A, V _{GS} = 0 V ^b | | - | - | 2.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T _J = 25 °C, I _F = 51 A, dl/dt = 100 A/μs ^b | | - | 130 | 180 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 0.84 | 1.3 | μC |
| Forward Turn-On Time | t _{on} | Intrinsic tu | rn-on is dominated by L _S and L | | | L _D) | |

- Notes a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width $\leq 300~\mu s$; duty cycle $\leq 2~\%$. c. Current limited by the package, (Die Current = 51 A).



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

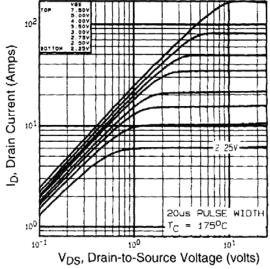


Fig. 2 - Typical Output Characteristics, $T_C = 150 \, ^{\circ}\text{C}$

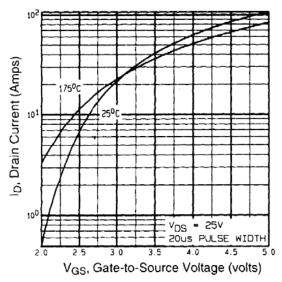


Fig. 3 - Typical Transfer Characteristics

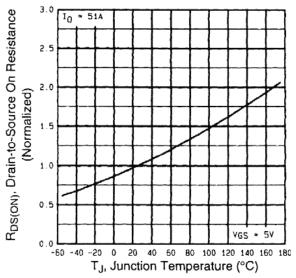


Fig. 4 - Normalized On-Resistance vs. Temperature



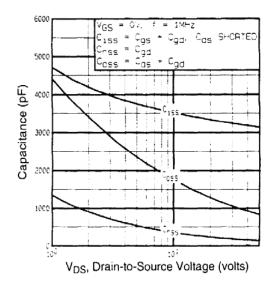


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

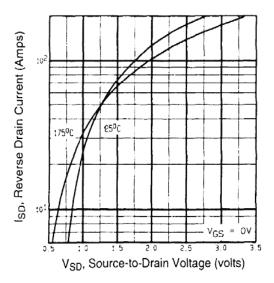


Fig. 7 - Typical Source-Drain Diode Forward Voltage

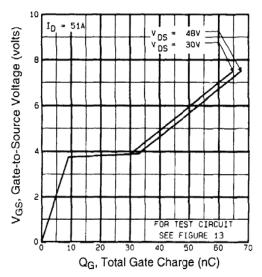


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

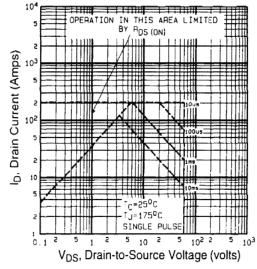


Fig. 8 - Maximum Safe Operating Area



5

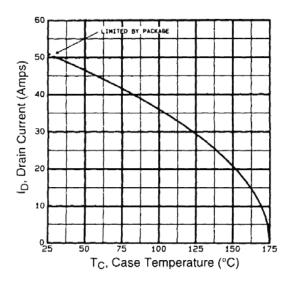


Fig. 9 - Maximum Drain Current vs. Case Temperature

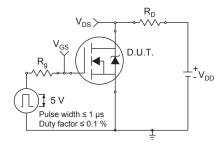


Fig. 10a - Switching Time Test Circuit

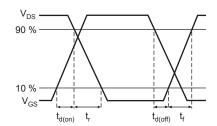


Fig. 10b - Switching Time Waveforms

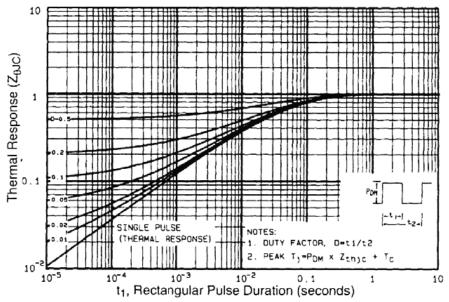
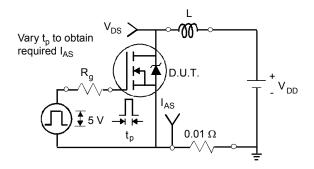


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





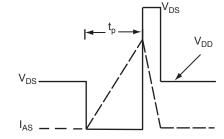


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

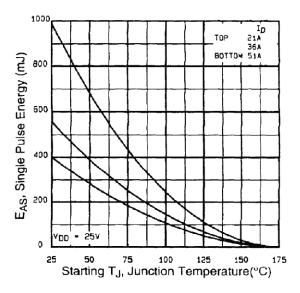


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

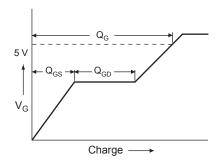


Fig. 13a - Basic Gate Charge Waveform

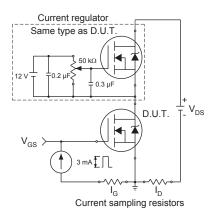
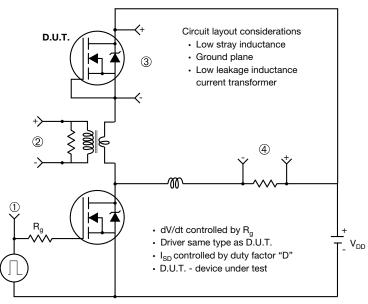


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



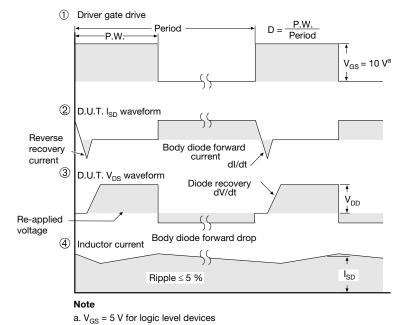
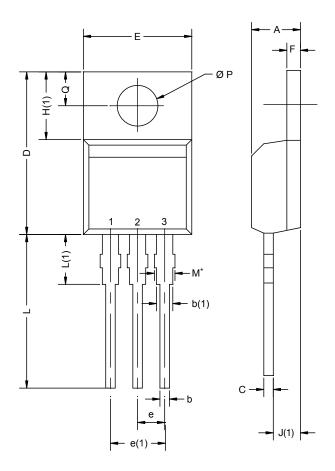


Fig. 14 - For N-Channel



TO-220AB



| | MILLIN | IETERS | INC | HES | | |
|---------------------------------|--------|--------|-------|-------|--|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | | |
| Α | 4.25 | 4.65 | 0.167 | 0.183 | | |
| b | 0.69 | 1.01 | 0.027 | 0.040 | | |
| b(1) | 1.20 | 1.73 | 0.047 | 0.068 | | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | | |
| D | 14.85 | 15.49 | 0.585 | 0.610 | | |
| E | 10.04 | 10.51 | 0.395 | 0.414 | | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | | |
| H(1) | 6.09 | 6.48 | 0.240 | 0.255 | | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | | |
| L | 13.35 | 14.02 | 0.526 | 0.552 | | |
| L(1) | 3.32 | 3.82 | 0.131 | 0.150 | | |
| ØΡ | 3.54 | 3.94 | 0.139 | 0.155 | | |
| Q | 2.60 | 3.00 | 0.102 | 0.118 | | |
| FCN: X12-0208-Rev. N. 08-Oct-12 | | | | | | |

ECN: X12-0208-Rev. N, 08-Oct-12 DWG: 5471

Notes

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
IPB80P04P405ATMA2 2N7002W-G MCAC30N06Y-TP MCQ7328-TP NTMC083NP10M5L BXP7N65D BXP4N65F AOL1454G
WMJ80N60C4 BXP2N20L BXP2N65D BXT1150N10J BXT1700P06M TSM60NB380CP ROG RQ7L055BGTCR DMNH15H110SK3-13
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